

### Product Change Notification / ASER-03XZDL400

# Date:

27-Jul-2022

# **Product Category:**

EL Backlight Driver ICs

# PCN Type:

Manufacturing Change

## **Notification Subject:**

CCB 4997 Final Notice: Qualification of MMT as an additional assembly site for selected HV509K6-G and HV509K6-G-M932 catalog part numbers (CPNs) available in 32L VQFN (5x5x0.9mm) package.

### Affected CPNs:

ASER-03XZDL400\_Affected\_CPN\_07272022.pdf ASER-03XZDL400\_Affected\_CPN\_07272022.csv

# Notification Text:

PCN Status: Final Notification

PCN Type: Manufacturing Change

**Microchip Parts Affected:**Please open one of the files found in the Affected CPNs section. Note: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

**Description of Change:**Qualification of MMT as an additional assembly site for selected HV509K6-G and HV509K6-G-M932 catalog part numbers (CPNs) available in 32L VQFN (5x5x0.9mm) package.

#### Pre and Post Change Summary:

|               | Pre Change      | Post Change     |                      |  |  |  |  |
|---------------|-----------------|-----------------|----------------------|--|--|--|--|
| Assembly Site | Carsem (Suzhou) | Carsem (Suzhou) | Microchip Technology |  |  |  |  |

|                              | (CARC)       | (CARC)             | Thailand<br>(MMT)                |  |  |  |
|------------------------------|--------------|--------------------|----------------------------------|--|--|--|
| Wire Material                | Au           | Au                 | Au                               |  |  |  |
| Die Attach Material          | QMI519       | QMI519             | QMI519                           |  |  |  |
| Molding Compound<br>Material | EME-G770HCD  | EME-G770HCD        | G700LTD                          |  |  |  |
| Lead-Frame Material          | A194         | A194               | A194                             |  |  |  |
| Lead-lock                    | No           | No                 | Yes                              |  |  |  |
| Lead-Frame Paddle Size       | 146x146 mils | 146x146 mils       | 150x150 mils                     |  |  |  |
|                              | See Pre ar   | nd Post Change Sur | t Change Summary for comparison. |  |  |  |
| DAP Surface Prep             | Spot Ag      | Spot Ag            | Bare Cu                          |  |  |  |
| Package Size                 | 5x5x1.0mm    | 5x5x1.0mm          | 5x5x0.9mm                        |  |  |  |

Impacts to Data Sheet:Yes - Updated POD.

|                            |           | 5x5  | x1.0mm - | CARC                                   | 5x5x0.9mm - MMT |       |      |  |  |  |
|----------------------------|-----------|------|----------|--|-----------------|-------|------|--|--|--|
| Feature                    | Dimension | MIN  | NOM      | MAX                                    | MIN             | NOM   | MAX  |  |  |  |
| Number of Pins             | n         |      | 32       |  | 32              |       |      |  |  |  |
| Pitch                      | е         |      | 0.50 BSC | `````````````````````````````````````` | 0.50 BSC        |       |      |  |  |  |
| Overall Height             | А         | 0.80 | 0.90     | 1.00                                   | 0.80            | 0.90  | 1.00 |  |  |  |
| Standoff                   | A1        | 0.00 | 0.02     | 0.05                                   | 0.00            | 0.035 | 0.05 |  |  |  |
| Terminal Thickness         | A3        |      | 0.20 REF | -                                      | 0.203 REF       |       |      |  |  |  |
| Overall Width              | D         |      | 5.00 BSC |  | 5.00 BSC        |       |      |  |  |  |
| Exposed Pad Width          | D2        | 3.30 | 3.45     | 3.55                                   | 3.00            | 3.10  | 3.20 |  |  |  |
| Overall Length             | E         |      | 5.00 BSC | ,<br>,                                 | 5.00 BSC        |       |      |  |  |  |
| Exposed Pad Length         | E2        | 3.30 | 3.45     | 3.55                                   | 3.00            | 3.10  | 3.20 |  |  |  |
| Terminal Width             | b         | 0.18 | 0.25     | 0.30                                   | 0.20            | 0.25  | 0.30 |  |  |  |
| Terminal Length            | L         | 0.30 | 0.40     | 0.50                                   | 0.35            | 0.40  | 0.45 |  |  |  |
| Terminal-to-Exposed<br>Pad | K         | 0.20 | -        | -                                      | 0.20            | -     | _    |  |  |  |

#### Change ImpactNone

**Reason for Change:**To improve on-time delivery performance by qualifying MMT as an additional assembly site.

Change Implementation Status: In Progress

### Estimated First Ship Date: September 2, 2022 (date code: 2236)

Note: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

#### Time Table Summary:

|                                     | March 2022 |        |        | >      | July 2022 |  |        | >      | September 2022 |        |        |  |        |        |        |        |        |
|-------------------------------------|------------|--------|--------|--------|-----------|--|--------|--------|----------------|--------|--------|--|--------|--------|--------|--------|--------|
| Workweek                            | 1<br>0     | 1<br>1 | 1<br>2 | 1<br>3 | 1<br>4    |  | 2<br>8 | 2<br>9 | 3<br>0         | 3<br>1 | 3<br>2 |  | 3<br>6 | 3<br>7 | 3<br>8 | 3<br>9 | 4<br>0 |
| Initial PCN Issue<br>Date           |            | Х      |        |        |           |  |        |        |                |        |        |  |        |        |        |        |        |
| Qual Report<br>Availability         |            |        |        |        |           |  |        |        |                | Х      |        |  |        |        |        |        |        |
| Final PCN Issue<br>Date             |            |        |        |        |           |  |        |        |                | Х      |        |  |        |        |        |        |        |
| Estimated<br>Implementation<br>Date |            |        |        |        |           |  |        |        |                |        |        |  | Х      |        |        |        |        |

#### Method to Identify Change: Traceability code

**Qualification Report:**Please open the attachments included with this PCN labeled as PCN\_#\_Qual\_Report.

#### Revision History: March 7, 2022: Issued initial notification.

July 27, 2022: Issued final notification. Attached the qualification report. Provided estimated first ship date to be on September 2, 2022. Updated subject and description's package dimension from 5x5x1.0mm to 5x5x0.9mm to reflect the correct package dimension for MMT assembly site.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

## Attachments:

PCN\_ASER-03XZDL400\_Pre and Post Change Summary.pdf PCN\_ASER-03XZDL400\_Qual\_Report.pdf Please contact your local Microchip sales office with questions or concerns regarding this notification.

#### **Terms and Conditions:**

If you wish to <u>receive Microchip PCNs via email</u> please register for our PCN email service at our <u>PCN</u> home page select register then fill in the required fields. You will find instructions about registering for Microchips PCN email service in the <u>PCN FAQ</u> section.

If you wish to <u>change your PCN profile</u>, <u>including opt out</u>, please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections. ASER-03XZDL400 - CCB 4997 Final Notice: Qualification of MMT as an additional assembly site for selected HV509K6-G and HV509K6-G-M932 catalog part numbers (CPNs) available in 32L VQFN (5x5x0.9mm) package.

Affected Catalog Part Numbers (CPN)

HV509K6-G HV509K6-G-M932